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Stock Code (1347)

News Release

Hua Hong Semiconductor Limited Reports 2022 First Quarter Results

All currency figures in this report are in US Dollars unless indicated otherwise. The consolidated financial statements are prepared in accordance with HKFRS.

Hong Kong Special Administrative Region of the People's Republic of China – May 12, 2022.

Hua Hong Semiconductor Limited (SEHK: 1347) (the "Company"), a global, leading pure-play foundry, today announced its consolidated operational results for the guarter ending March 31, 2022.

First Quarter 2022 Highlights (Unaudited)

- Revenue hit an all-time high of US\$594.6 million, up 95.1% year over year and 12.6% above the prior quarter.
- Gross margin was 26.9%, 3.2 percentage points over 1Q 2021 and 5.6 percentage points below 4Q 2021.
- Net profit was US\$102.1 million, 387.9% over 1Q 2021 and 25.6% below 4Q 2021.
- Net profit attributable to shareholders of the parent company was US\$102.9 million, 211.4% over 1Q 2021 and 22.9% below 4Q 2021.
- Basic earnings per share was US\$0.079, 216.0% over 1Q 2021 and 23.3% below 4Q 2021.
- ROE (annualized) was 14.1%, 8.9 percentage points over 1Q 2021 and 5.1 percentage points below 4Q 2021.

Second Quarter 2022 Guidance

- We expect revenue to be approximately US\$615 million.
- We expect gross margin to be in the range of 28% to 29%.

President's Message

Mr. Tang Junjun, President and Executive Director of the Company, commented on 1Q22 results:

"Facing a complex situation with pressure from COVID and the changing market, Hua Hong Semiconductor is adhering to its 'Specialty IC + Power Discrete' strategy and delivered encouraging results in the first quarter of 2022. Our differentiated platforms, such as NVM, Power Discrete, Analog & Power Management IC, Logic & RF, and CIS, made steady progress and continued to produce revenue growth. The Company's 1Q22 revenue reached a record high of \$594.6 million, a year-on-year increase of 95.1%, and a quarter-on-quarter increase of 12.6%. Revenue from the 12-inch fab accounted for 44.1% of the total revenue, versus 17.9% in 1Q21 and 38.9% in 4Q21. In the context of continued global chip shortages in fields such as Automotive Electronic and New Energy, demand for specialty technologies has remained high, boosting the average selling price for all products. Demand continues to rise, assuring rapid growth of the Company."

Mr. Tang continued, "We are now facing the urgent task of COVID prevention and control and the world's economic recovery will be bumpy. Difficulties often come with opportunities and challenges often lead to invention. The Company has designed a pandemic prevention and control system, which is strictly implemented by all employees. As at today, the Company has demonstrated effective pandemic prevention and control results, orderly production organization, and fully-utilized capacity, with a highly-motivated workforce. We have always believed the best way to deal with difficulties is to focus on development, overcoming challenges by innovation. As an indispensable part of the integrated circuit industry, we have opportunities in a vast market, including Automotive Electronics, Industrial Control, Green Energy, Internet of Things, and New-generation Communications. We will continue making greater marketing-focused R&D-oriented investments, providing 'Specialty IC + Power Discrete' platforms, delivering to our customers differentiated product solutions with better performance, lower power consumption, and enhanced reliability. In order to set a solid foundation for our development strategy, increase our influence in the global foundry space, expand our business scale, and strengthen our 'Specialty IC + Power Discrete' platforms, we will expedite the next phase of construction for Hua Hong Wuxi's 12-inch production line at full speed to fulfill the ever-growing demand.

I would like to thank all of our shareholders, customers, and vendors for their tremendous support. All employees will earnestly implement the 'Four Protections' COVID-related requirements, stick to their positions, dedicate themselves to the Company's future, and focus on high-quality development of our specialty technologies. I believe Hua Hong Semiconductor is bound to set a new record and create a higher level of achievement through our unremitting efforts."

Webcast/Conference Call Announcement

Date: Thursday, May 12, 2022

Time: 16:00 Hong Kong/Shanghai Time

04:00 EST

Presenters: Mr. Junjun Tang, President and Executive Director

Mr. Daniel Wang, Executive Vice President and Chief Financial Officer

Webcast: The call will be webcast live with audio and slides at:

http://www.huahonggrace.com/html/investor_webcast.php or

https://edge.media-server.com/mmc/p/7m7kiwn6

(Note: registration is required to access the webcast.)

Dial-in Details: Please register in advance of the conference using the link provided below. Upon

registering, you will be provided with participant dial-in numbers, Direct Event

passcode and unique registrant ID.

http://apac.directeventreg.com/registration/event/8548907

Important Note: Before the meeting starts, you will need both the passcode and unique registrant ID to join the call. Please check and save the confirmation email after registering. For security reasons, please do not share your registrant ID with

anyone else.

Conference ID: 8548907

Replay: A recording will be available for replay at the below website about 24 hours after the

event and will be available for 12 months.

http://www.huahonggrace.com/s/investor_webcast.php

About the Company

Hua Hong Semiconductor Limited ("Hua Hong Semiconductor", stock code: 1347.HK) (the "Company") is a global, leading pure-play foundry focused on continuous innovation of "8-inch+12-inch" specialty technologies, including embedded non-volatile memory ("eNVM"), power discrete, analog & power management, and logic & RF, supporting applications in emerging areas, such as the Internet of Things, using "Specialty IC + Power Discrete" technology platforms. Of special note is the Company's outstanding quality control system that satisfies the strict requirements of automotive chip manufacturing. The Company is part of the Huahong Group, an enterprise group whose main business is IC manufacturing, with advanced "8-inch+12-inch" production line technology.

The Company presently operates three 8-inch wafer fabrication facilities (HH Fab1, HH Fab2, and HH Fab3) in Jinqiao and Zhangjiang, Shanghai, with a total monthly 8-inch wafer capacity of approximately 180,000 wafers. The 12-inch wafer fabrication facility (HH Fab7) in Wuxi's National High-Tech Industrial Development Zone, at a 65,000 wafer per month capacity, has become a leading 12-inch semiconductor production line in the Chinese mainland devoted to specialty processes and is the first 12-inch foundry in the world devoted to power discrete semiconductors.

For more information, please visit: www.huahonggrace.com.

Summary of Operating Results (Amounts in US\$ thousands, except for EPS and operating data)

| | 1Q 2022 | 1Q 2021 | 4Q 2021 | YoY | QoQ |
|---|-------------|-------------|-------------|---------|----------|
| | (Unaudited) | (Unaudited) | (Unaudited) | Change | Change |
| Revenue | 594,648 | 304,843 | 528,317 | 95.1 % | 12.6 % |
| Cost of sales | (434,625) | (232,685) | (356,800) | 86.8 % | 21.8 % |
| Gross profit | 160,023 | 72,158 | 171,517 | 121.8 % | (6.7)% |
| Gross margin | 26.9 % | 23.7 % | 32.5 % | 3.2 | (5.6) |
| Operating expenses | (75,264) | (59,502) | (31,866) | 26.5 % | 136.2 % |
| Other income net | 10,479 | 7,121 | 27,812 | 47.2 % | (62.3)% |
| Profit before tax | 95,238 | 19,777 | 167,463 | 381.6 % | (43.1)% |
| Income tax credit / (expense) | 6,865 | 1,148 | (30,213) | 498.0 % | (122.7)% |
| Profit for the period | 102,103 | 20,925 | 137,250 | 387.9 % | (25.6)% |
| Net profit margin | 17.2 % | 6.9% | 26.0% | 10.3 | (8.8) |
| Attributable to: | | | | | |
| Owners of the parent | 102,944 | 33,059 | 133,528 | 211.4 % | (22.9)% |
| Non-controlling interests | (841) | (12,134) | 3,722 | (93.1)% | (122.6)% |
| Earnings per share attributable to owners of the parent | | | | | |
| Basic | 0.079 | 0.025 | 0.103 | 216.0 % | (23.3)% |
| Diluted | 0.078 | 0.025 | 0.101 | 212.0 % | (22.8)% |
| Wafers shipped (in thousands 8" equivalent wafers) | 1,057 | 669 | 1,022 | 58.0 % | 3.4 % |
| Capacity utilization ¹ | 106.0 % | 104.2 % | 105.4 % | 1.8 | 0.6 |
| ROE ² | 14.1 % | 5.2 % | 19.2 % | 8.9 | (5.1) |

First Quarter 2022

- Revenue reached an all-time high of US\$594.6 million, 95.1% over the prior year and 12.6% above the prior guarter.
- Cost of sales was US\$434.6 million, 86.8% over 1Q 2021, largely due to increased wafer shipments, and 21.8% above 4Q 2021, mainly due to increased bonus and depreciation costs.
- Gross margin was 26.9%, 3.2 percentage points over 1Q 2021, primarily due to improved average selling price, partially offset by increased depreciation costs, and 5.6 percentage points below 4Q 2021, mainly due to an audit adjustment on government grants, increased bonus and depreciation costs, partially offset by improved average selling price.
- Operating expenses were US\$75.3 million, 26.5% over 1Q 2021, mainly due to increased bonus, and 136.2% over 4Q 2021, primarily due to an audit adjustment on government grants and increased bonus.
- Other income net was US\$10.5 million, 47.2% over 1Q 2021, primarily due to foreign exchange gains versus foreign exchange losses in 1Q 2021, partially offset by increased finance costs, and 62.3% below 4Q 2021, largely due to decreased foreign exchange gains.
- *Income tax credit* was US\$6.9 million, 498.0% over 1Q 2021, primarily due to a reversal of increased dividend withholding tax accrued for the prior year, partially offset by tax expenses.
- Profit for the period was U\$\$102.1 million, 387.9% over 1Q 2021 and 25.6% below 4Q 2021.
- Net profit attributable to shareholders of the parent company was US\$102.9 million, 211.4% over 1Q 2021 and 22.9% below 4Q 2021.
- Basic earnings per share was US\$0.079, 216.0% over 1Q 2021 and 23.3% below 4Q 2021.
- ROE (annualized) was 14.1%, 8.9 percentage points over 1Q 2021 and 5.1 percentage points below 4Q 2021.

¹The capacity utilization is calculated based on average monthly equivalent wafers output divided by total estimated monthly capacity.

²Profit attributable to owners of the parent / weighted average net assets attributable to owners of the parent.

Operating Results by Segment³ (Amounts in US\$ thousands, except for operating data)

| (Amounts | in US\$ thousand | s, except for o | perating data) | | |
|---|------------------|-----------------|----------------|-----------|------------|
| | 1Q 2022 | 1Q 2021 | 4Q 2021 | YoY | QoQ |
| | (Unaudited) | (Unaudited) | (Unaudited) | Change | Change |
| Hua Hong 8" | | | | | |
| Revenue | 332,603 | 250,196 | 322,631 | 32.9 % | 3.1 % |
| Gross profit | 128,451 | 68,194 | 146,589 | 88.4 % | (12.4)% |
| Gross margin | 38.6 % | 27.3 % | 45.4 % | 11.3 | (6.8) |
| Operating expenses | (40,587) | (32,528) | 3,101 | 24.8 % | (1,408.8)% |
| Profit before tax | 94,629 | 44,540 | 157,562 | 112.5 % | (39.9)% |
| EBITDA | 130,824 | 82,883 | 174,328 | 57.8 % | (25.0)% |
| EBITDA margin | 39.3 % | 33.1 % | 54.0 % | 6.2 | (14.7) |
| Wafers shipped (in thousands 8" wafers) | 571 | 541 | 617 | 5.5 % | (7.5)% |
| Hua Hong Wuxi | | | | | |
| Revenue | 262,045 | 54,647 | 205,686 | 379.5 % | 27.4 % |
| Gross profit | 31,572 | 3,964 | 24,928 | 696.5 % | 26.7 % |
| Gross margin | 12.0 % | 7.3 % | 12.1 % | 4.7 | (0.1) |
| Operating expenses | (34,677) | (26,974) | (34,967) | 28.6 % | (0.8)% |
| Profit before tax | 609 | (24,763) | 9,901 | (102.5)% | (93.8)% |
| EBITDA | 88,427 | 9,688 | 78,230 | 812.7 % | 13.0 % |
| EBITDA margin | 33.7 % | 17.7 % | 38.0 % | 16.0 | (4.3) |
| Wafers shipped (in thousands 8"equivalent wafers) | 486 | 128 | 405 | 279.7 % | 20.0 % |

Hua Hong 8"

- Revenue was US\$332.6 million, 32.9% over 1Q 2021 and 3.1% above 4Q 2021.
- Gross margin was 38.6%, 11.3 percentage points over 1Q 2021, mainly due to improved average selling price and product mix, and 6.8 percentage points lower than 4Q 2021, primarily due to an audit adjustment on government grants and increased bonus, partially offset by improved average selling price.
- Operating expenses were US\$40.6 million, 24.8% over 1Q 2021, largely due to increased bonus, and 1,408.8% above 4Q 2021, primarily due to an audit adjustment on government grants.
- Profit before tax was US\$94.6 million, 112.5 % over 1Q 2021 and 39.9% below 4Q 2021.

Hua Hong Wuxi

- Revenue was US\$262.0 million, 379.5% over 1Q 2021 and 27.4% above 4Q 2021.
- Gross margin was 12.0%, 4.7 percentage points over 1Q 2021 and 0.1 percentage point below 4Q 2021.
- Operating expenses were US\$34.7 million, 28.6% above 1Q 2021, primarily due to increased bonus and engineering wafer costs.
- EBITDA was US\$88.4 million, 13.0% over 4Q 2021.

³ The operating results of each operating segment are figures after netting of inter-segment elimination.

| Revenue by service type | 1Q 2022 US\$000 (Unaudited) | 1Q 2022 % (Unaudited) | 1Q 2021 US\$000 (Unaudited) | 1Q 2021 % (Unaudited) | YoY Change US\$000 | YoY Change % |
|-------------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|--------------------------|--------------------|
| Wafers | 574,651 | 96.6 % | 291,834 | 95.7 % | 282,817 | 96.9 % |
| Others | 19,997 | 3.4 % | 13,009 | 4.3 % | 6,988 | 53.7 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

■ 96.6% of total revenue was derived from the sale of semiconductor wafers in 1Q 2022.

Analysis of Revenue

| Revenue by wafer size | 1Q 2022 US\$000 (Unaudited) | 1Q 2022 % (Unaudited) | 1Q 2021 US\$000 (Unaudited) | 1Q 2021 % (Unaudited) | YoY Change US\$000 | YoY Change % |
|-----------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|--------------------------|--------------------|
| 8" wafers | 332,603 | 55.9 % | 250,196 | 82.1 % | 82,407 | 32.9 % |
| 12" wafers | 262,045 | 44.1 % | 54,647 | 17.9 % | 207,398 | 379.5 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

■ Revenues from 8" wafers and 12" wafers were US\$332.6 million and US\$262.0 million, respectively, in 1Q 2022.

| Revenue by geography | 1Q 2022 US\$000 (Unaudited) | 1Q 2022 % (Unaudited) | 1Q 2021 US\$000 (Unaudited) | 1Q 2021 % (Unaudited) | YoY Change US\$000 | YoY Change % |
|----------------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|--------------------------|--------------------|
| China ⁴ | 451,638 | 76.0 % | 219,735 | 72.0 % | 231,903 | 105.5 % |
| United States ⁵ | 58,064 | 9.8 % | 28,309 | 9.3 % | 29,755 | 105.1 % |
| Asia ⁶ | 54,885 | 9.2 % | 35,894 | 11.8 % | 18,991 | 52.9 % |
| Europe | 22,081 | 3.7 % | 14,801 | 4.9 % | 7,280 | 49.2 % |
| Japan ⁷ | 7,980 | 1.3 % | 6,104 | 2.0 % | 1,876 | 30.7 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

- Revenue from China was US\$451.6 million, contributing 76.0% of total revenue and an increase of 105.5% over 1Q 2021, mainly due to increased demand for all technology platforms.
- Revenue from United States was US\$58.1 million, an increase of 105.1% over 1Q 2021, mainly due to increased demand for other PMIC products.
- Revenue from Asia was US\$54.9 million, an increase of 52.9% over 1Q 2021, mainly due to increased demand for logic, general MOSFET, and MCU products.
- Revenue from Europe was US\$22.1 million, an increase of 49.2% over 1Q 2021, mainly due to increased demand for smart card ICs, general MOSFET and IGBT products.
- Revenue from Japan was US\$8.0 million, an increase of 30.7% over 1Q 2021, primarily due to increased demand for MCU products.

⁴Includes Hong Kong.

⁵Includes a major customer in US that was acquired by an Europe headquartered company in 2020.

⁶Excludes China and Japan.

⁷Includes a major customer in Japan that was acquired by a U.S. headquartered company in 2013.

| Revenue by technology platform | 1Q 2022 US\$000 (Unaudited) | 1Q 2022 % (Unaudited) | 1Q 2021 US\$000 (Unaudited) | 1Q 2021 % (Unaudited) | YoY Change US\$000 | YoY Change % |
|--------------------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|--------------------------|--------------------|
| eNVM | 142,258 | 23.9 % | 94,506 | 31.0 % | 47,752 | 50.5 % |
| Standalone NVM | 58,546 | 9.8 % | 11,569 | 3.8 % | 46,977 | 406.1 % |
| Discrete | 181,342 | 30.6 % | 109,547 | 35.9 % | 71,795 | 65.5 % |
| Logic & RF | 95,327 | 16.0 % | 49,844 | 16.4 % | 45,483 | 91.3 % |
| Analog & PM | 116,557 | 19.6 % | 38,771 | 12.7 % | 77,786 | 200.6 % |
| Others | 618 | 0.1 % | 606 | 0.2 % | 12 | 2.0 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

- Revenue from eNVM was US\$142.3 million, an increase of 50.5% over 1Q 2021, mainly due to increased demand for MCU and smart card ICs.
- Revenue from Standalone NVM was US\$58.5 million, an increase of 406.1% over 1Q 2021, primarily due to increased demand for NOR flash products.
- Revenue from discrete was US\$181.3 million, an increase of 65.5% over 1Q 2021, mainly due to increased demand for super junction, IGBT, general MOSFET products
- Revenue from logic & RF was US\$95.3 million, an increase of 91.3% over 1Q 2021, mainly due to increased demand for CIS and logic products.
- Revenue from analog & power management was US\$116.6 million, an increase of 200.6% over 1Q 2021, mainly due to increased demand for other PMIC products.

| Revenue by | 1Q 2022 | 1Q 2022 | 1Q 2021 | 1Q 2021 | YoY | YoY |
|-----------------|-------------|-------------|-------------|-------------|---------|---------|
| process | US\$000 | % | US\$000 | % | Change | Change |
| technology node | (Unaudited) | (Unaudited) | (Unaudited) | (Unaudited) | US\$000 | % |
| 55nm & 65nm | 103,031 | 17.3 % | 12,685 | 4.2 % | 90,346 | 712.2 % |
| 90nm & 95nm | 124,360 | 21.0 % | 44,987 | 14.8 % | 79,373 | 176.4 % |
| 0.11µm & 0.13µm | 82,825 | 13.9 % | 63,945 | 21.0 % | 18,880 | 29.5 % |
| 0.15µm & 0.18µm | 48,626 | 8.2 % | 36,334 | 11.9 % | 12,292 | 33.8 % |
| 0.25µm | 3,802 | 0.6 % | 4,594 | 1.5 % | (792) | (17.2)% |
| ≥0.35µm | 232,004 | 39.0 % | 142,298 | 46.6 % | 89,706 | 63.0 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

- Revenue from the 55nm & 65nm technology nodes was US\$103.0 million, an increase of 712.2% over 1Q 2021, mainly due to NOR flash, CIS, and logic products.
- Revenue from the 90nm & 95nm technology nodes was US\$124.4 million, an increase of 176.4% over 1Q 2021, mainly due to increased demand for other PMIC, MCU, and smart card ICs.
- Revenue from the 0.11µm & 0.13µm technology nodes was US\$82.8 million, an increase of 29.5% over 1Q 2021, mainly due to increased demand for MCU products.
- Revenue from the 0.15µm & 0.18µm technology nodes was US\$48.6 million, an increase of 33.8% over 1Q 2021, mainly due to increased demand for logic and other PMIC products.
- Revenue from the 0.25µm technology node was US\$3.8 million, a decrease of 17.2% over 1Q 2021, primarily due to decreased demand for RF products.
- Revenue from the 0.35μm and above technology nodes was US\$232.0 million, an increase of 63.0% over 1Q 2021, mainly due to increased demand for super junction, IGBT, general MOSFET, and other PMIC products.

| Revenue by end market distribution | 1Q 2022 US\$000 (Unaudited) | 1Q 2022 % (Unaudited) | 1Q 2021 US\$000 (Unaudited) | 1Q 2021 % (Unaudited) | YoY Change US\$000 | YoY Change % |
|------------------------------------|-----------------------------------|-----------------------------|-----------------------------------|-----------------------------|--------------------------|--------------------|
| Consumer electronics | 395,076 | 66.3 % | 189,038 | 62.0 % | 206,038 | 109.0 % |
| Industrial & automotive | 106,154 | 17.9 % | 59,998 | 19.7 % | 46,156 | 76.9 % |
| Communications | 72,847 | 12.3 % | 44,244 | 14.5 % | 28,603 | 64.6 % |
| Computing | 20,571 | 3.5 % | 11,563 | 3.8 % | 9,008 | 77.9 % |
| Total revenue | 594,648 | 100.0 % | 304,843 | 100.0 % | 289,805 | 95.1 % |

- Revenue from consumer electronics, our largest end market segment, contributed US\$395.1 million, reaching 66.3% of total revenue, an increase of 109.0% over 1Q 2021, mainly due to increased demand for all technology platforms.
- Revenue from industrial & automotive was US\$106.2 million, an increase of 76.9% over 1Q 2021, mainly due to increased demand for IGBT, MCU, and smart card ICs.
- Revenue from communications was US\$72.8 million, an increase of 64.6% over 1Q 2021, mainly due to increased demand for CIS, logic and smart card ICs.
- Revenue from computing was US\$20.6 million, an increase of 77.9% over 1Q 2021, mainly due to increased demand for general MOSFET and MCU products.

Capacity⁸ and Capacity Utilization

| • | handled and ambanded a | | |
|-------------------------------------|------------------------|------------------------|------------------------|
| Fab (in thousands wafers per month) | 1Q 2022 (Unaudited) | 1Q 2021 (Unaudited) | 4Q 2021 (Unaudited) |
| Fab 1 (200mm) | 65 | 65 | 65 |
| Fab 2 (200mm) | 60 | 60 | 60 |
| Fab 3 (200mm) | 53 | 53 | 53 |
| Fab 7 (300mm) | 65 | 28 | 60 |
| Total 8" equivalent wafers | 324 | 241 | 313 |
| Capacity utilization (200mm) | 107.7% | 104.3% | 107.5% |
| Capacity utilization (300mm) | 103.9% | 103.8% | 102.5% |
| Overall capacity utilization | 106.0% | 104.2% | 105.4% |

■ Monthly capacity was 324,000 8-inch equivalent wafers at the end of 1Q 2022. Overall capacity utilization was 106.0% in 1Q 2022.

⁸ Wafers per month at the end of the period, calculated on a 30-day basis for comparison purposes.

Wafer Shipments

| in thousands 8" | 1Q 2022 | 1Q 2021 | 4Q 2021 | YoY | QoQ |
|-------------------|-------------|-------------|-------------|--------|--------|
| equivalent wafers | (Unaudited) | (Unaudited) | (Unaudited) | Change | Change |
| Wafer shipments | 1,057 | 669 | 1,022 | 58.0 % | 3.4 % |

■ Wafer shipments were 1,057,000, an increase of 58.0% year over year and 3.4% quarter over quarter.

Operating Expenses Analysis

| Amounts in US\$ thousands | 1Q 2022 (Unaudited) | 1Q 2021 (Unaudited) | 4Q 2021 (Unaudited) | YoY Change | QoQ Change |
|-----------------------------------|------------------------|------------------------|------------------------|---------------|---------------|
| Selling and distribution expenses | 4,496 | 2,620 | 3,158 | 71.6 % | 42.4 % |
| Administrative expenses9 | 70,768 | 56,882 | 28,708 | 24.4 % | 146.5 % |
| Operating expenses | 75,264 | 59,502 | 31,866 | 26.5 % | 136.2% |

Operating expenses were US\$75.3 million, 26.5% over 1Q 2021, mainly due to increased bonus, and 136.2% over 4Q 2021, primarily due to an audit adjustment on government grants and increased bonus.

Other Income Net Analysis

| Amounts in US\$ thousands | 1Q 2022 (Unaudited) | 1Q 2021 (Unaudited) | 4Q 2021 (Unaudited) | YoY Change | QoQ Change |
|-----------------------------------|------------------------|------------------------|------------------------|---------------|---------------|
| Rental income | 3,781 | 3,680 | 3,614 | 2.7 % | 4.6 % |
| Interest income | 4,322 | 3,037 | 3,441 | 42.3 % | 25.6 % |
| Foreign exchange gains / (losses) | 7,140 | (269) | 21,619 | (2,754.3)% | (67.0)% |
| Share of profit of associates | 1,855 | 1,512 | 2,436 | 22.7 % | (23.9)% |
| Finance costs | (6,786) | (1,636) | (4,997) | 314.8 % | 35.8 % |
| Government subsidies | 1,842 | 544 | 826 | 238.6 % | 123.0 % |
| Others | (1,675) | 253 | 873 | (762.1)% | (291.9)% |
| Other income net | 10,479 | 7,121 | 27,812 | 47.2 % | (62.3)% |

Other income net was US\$10.5 million, 47.2% over 1Q 2021, primarily due to foreign exchange gains versus foreign exchange losses in 1Q 2021, partially offset by increased finance costs, and 62.3% below 4Q 2021, mainly due to decreased foreign exchange gains.

 $^{^9} Administrative$ expenses include government grants recognized as an offset item.

Cash Flow Analysis

| Amounts in US\$ thousands | 1Q 2022 (Unaudited) | 1Q 2021 (Unaudited) | 4Q 2021 (Unaudited) | YoY Change | QoQ Change |
|--|------------------------|------------------------|------------------------|---------------|---------------|
| Net cash flows generated from operating activities | 195,589 | 60,831 | 206,804 | 221.5 % | (5.4)% |
| Net cash flows used in investing activities | (116,986) | (167,528) | (297,044) | (30.2)% | (60.6)% |
| Net cash flows generated from financing activities | 2,439 | 146,928 | 242,187 | (98.3)% | (99.0)% |
| Effect of exchange rate changes | 3,752 | (1,511) | 13,846 | (348.3)% | (72.9)% |
| Net change in cash | 84,794 | 38,720 | 165,793 | 119.0 % | (48.9)% |

- Net cash flows generated from operating activities was US\$195.6 million, 221.5% over 1Q 2021, primarily due to increased revenue, partially offset by increased payments for payrolls and materials.
- Net cash flows used in investing activities was US\$117.0 million, including US\$124.1 million of investment in fixed and intangible assets, partially offset by US\$4.4 million of receipts of government grants for equipment and US\$2.7million of interest income.
- Net cash flows generated from financing activities was US\$2.4 million, including US\$47.4 million proceeds from bank borrowings and US\$1.2 million proceeds from share option exercises, partially offset by US\$43.2 million of repayment of bank borrowings, US\$2.5 million of lease payments, and US\$0.5 million of interest expenses for bank borrowings.

Capital Structure

| Amounts in US\$ thousands | 31-Mar-2022 (Unaudited) | 31-Dec-2021 (Unaudited) | |
|---------------------------|----------------------------|----------------------------|--|
| Total assets | 6,316,078 | 6,202,099 | |
| Total liabilities | 2,531,648 | 2,517,552 | |
| Total equity | 3,784,430 | 3,684,547 | |
| Debt ratio ¹⁰ | 40.1% | 40.6% | |

Capital Expenditures

| Amounts in US\$ thousands | 1Q 2022 (Unaudited) | 4Q 2021 (Unaudited) |
|---------------------------|------------------------|------------------------|
| Hua Hong 8" | 16,553 | 29,779 |
| Hua Hong Wuxi | 107,527 | 352,457 |
| Total | 124,080 | 382,236 |

■ Capital expenditures were US\$124.1 million in 1Q 2022, including US\$107.5 million for the Wuxi fab.

¹⁰ Debt ratio is calculated based on total liabilities / total assets.

Liquidity

| Amounts in US\$ thousands | 31-Mar-2022 | 31-Dec-2021 |
|---|-------------|-------------|
| | (Unaudited) | (Unaudited) |
| Properties under development | 125,110 | 114,492 |
| Inventories | 451,671 | 432,917 |
| Trade and notes receivables | 243,443 | 181,042 |
| Prepayments, other receivables and other assets | 50,060 | 43,443 |
| Due from related parties | 7,074 | 6,910 |
| Restricted and time deposits | 2,258 | 2,248 |
| Cash and cash equivalents | 1,694,934 | 1,610,140 |
| Total current assets | 2,574,550 | 2,391,192 |
| Trade payables | 243,211 | 194,385 |
| Other payables and accruals | 513,204 | 560,435 |
| Interest-bearing bank borrowings | 194,304 | 195,024 |
| Lease liabilities | 2,524 | 1,676 |
| Government grants | 67,127 | 66,837 |
| Due to related parties | 19,949 | 7,501 |
| Income tax payable | 67,538 | 54,543 |
| Total current liabilities | 1,107,857 | 1,080,401 |
| Net working capital | 1,466,693 | 1,310,791 |
| Quick ratio | 1.9x | 1.8x |
| Current ratio | 2.3x | 2.2x |
| Trade and notes receivables turnover days | 32 | 29 |
| Inventories turnover days | 92 | 105 |

- *Trade and notes receivables* increased from US\$181.0 million on 31 December 2021 to US\$243.4 million on 31 March 2022, mainly due to increased revenue.
- Prepayments, other receivables and other assets increased from US\$43.4 million on 31 December 2021 to US\$50.1 million on 31 March 2022, primarily due to increased prepayments to suppliers.
- *Trade payables* increased from US\$194.4 million on 31 December 2021 to US\$243.2 million on 31 March 2022, primarily due to increased payables to suppliers.
- Other payables and accruals decreased from US\$560.4 million on 31 December 2021 to US\$513.2 million on 31 March 2022, mainly due to decreased payables for capital expenditures.
- Due to related parties increased from US\$7.5 million on 31 December 2021 to US\$19.9 million on 31 March 2022, primarily due to receipt of a rental prepayment from one of our related parties.
- Income tax payable increased from US\$54.5 million on 31 December 2021 to US\$67.5 million on 31 March 2022, mainly due to accrued income tax for the period.
- On 31 March 2022, net working capital was US\$1,466.7 million and the current ratio was 2.3.
- Trade and notes receivables turnover days were 32.
- Inventories turnover days were 92.

Please visit Company's website at www.huahonggrace.com for further details regarding recent announcements.

Hua Hong Semiconductor Limited Condensed Consolidated Statements of Profit or Loss (In US\$ Thousands Except Share Data)

| ` | For the Three Months Ended | | |
|--|----------------------------|---------------|---------------|
| | 31-Mar-2022 (Unaudited) | | |
| Revenue | 594,648 | 304,843 | 528,317 |
| Cost of sales | (434,625) | (232,685) | (356,800) |
| Gross profit | 160,023 | 72,158 | 171,517 |
| Other income and gains | 17,721 | 7,604 | 30,190 |
| Fair value gain on an investment property | (316) | - | 183 |
| Selling and distribution expenses | (4,496) | (2,620) | (3,158) |
| Administrative expenses | (70,768) | (56,882) | (28,708) |
| Other expenses | (1,995) | (359) | - |
| Finance costs | (6,786) | (1,636) | (4,997) |
| Share of profit of associates | 1,855 | 1,512 | 2,436 |
| Profit before tax | 95,238 | 19,777 | 167,463 |
| Income tax credit / (expense) | 6,865 | 1,148 | (30,213) |
| Profit for the period | 102,103 | 20,925 | 137,250 |
| Attributable to: | | | |
| Owners of the parent | 102,944 | 33,059 | 133,528 |
| Non-controlling interests | (841) | (12,134) | 3,722 |
| Earnings per share attributable to owners of parent | | | |
| Basic | 0.079 | 0.025 | 0.103 |
| Diluted | 0.078 | 0.025 | 0.101 |
| Shares used in calculating basic earnings per share attributable to owners of parent | 1,301,453,841 | 1,299,428,463 | 1,300,675,399 |
| Shares used in calculating diluted earnings per share attributable to owners of parent | 1,319,204,155 | 1,325,196,463 | 1,320,444,781 |

Hua Hong Semiconductor Limited Condensed Consolidated Statements of Financial Position (In US\$ Thousands)

| | , | As of | • |
|--|-------------|-------------|-------------|
| | 31-Mar-2022 | 31-Dec-2021 | 31-Mar-2021 |
| 100570 | (Unaudited) | (Audited) | (Unaudited) |
| ASSETS | | | |
| NON-CURRENT ASSETS | 0.050.444 | 0.440.504 | 0.400.405 |
| Property, plant and equipment | 3,053,141 | 3,116,501 | 2,498,485 |
| Investment property | 185,369 | 184,883 | 179,202 |
| Right-of-use assets | 76,681 | 75,331 | 77,050 |
| Intangible assets | 33,487 | 35,312 | 36,841 |
| Investment in associates | 124,420 | 122,040 | 107,436 |
| Equity instruments designated at fair value through other comprehensive income | 236,005 | 257,788 | 228,639 |
| Long term prepayment | 23,710 | 15,573 | 29,447 |
| Due from related parties | - | - | 17 |
| Deferred tax assets | 8,715 | 3,479 | 9,538 |
| Total non-current assets | 3,741,528 | 3,810,907 | 3,166,655 |
| CURRENT ASSETS | | | |
| Properties under development | 125,110 | 114,492 | 106,040 |
| Inventories | 451,671 | 432,917 | 283,764 |
| Trade and notes receivables | 243,443 | 181,042 | 127,613 |
| Prepayments, other receivables and other assets | 50,060 | 43,443 | 29,280 |
| Due from related parties | 7,074 | 6,910 | 7,220 |
| Restricted and time deposits | 2,258 | 2,248 | 356 |
| Cash and cash equivalents | 1,694,934 | 1,610,140 | 961,506 |
| Total current assets | 2,574,550 | 2,391,192 | 1,515,779 |
| CURRENT LIABILITIES | | | |
| Trade payables | 243,211 | 194,385 | 124,799 |
| Other payables and accruals | 513,204 | 560,435 | 346,232 |
| Interest-bearing bank borrowings | 194,304 | 195,024 | 90,959 |
| Lease liabilities | 2,524 | 1,676 | 1,884 |
| Government grants | 67,127 | 66,837 | 67,609 |
| Due to related parties | 19,949 | 7,501 | 23,469 |
| Income tax payable | 67,538 | 54,543 | 31,432 |
| Total current liabilities | 1,107,857 | 1,080,401 | 686,384 |
| NET CURRENT ASSETS | 1,466,693 | 1,310,791 | 829,395 |
| TOTAL ASSETS LESS CURRENT LIABILITIES | 5,208,221 | 5,121,698 | 3,996,050 |
| Non-current liabilities | | | |
| Interest-bearing bank borrowings | 1,400,496 | 1,395,279 | 618,261 |
| Lease liabilities | 15,429 | 16,137 | 16,689 |
| Deferred tax liabilities | 7,866 | 25,735 | 5,583 |
| Total non-current liabilities | 1,423,791 | 1,437,151 | 640,533 |
| Net assets | 3,784,430 | 3,684,547 | 3,355,517 |
| Equity and liabilities capital and reserves | | | |
| Share capital | 1,987,216 | 1,986,152 | 1,984,004 |
| Reserves | 980,308 | 884,207 | 563,599 |
| Equity attributable to the owners of the company | 2,967,524 | 2,870,359 | 2,547,603 |
| Non-controlling interests | 816,906 | 814,188 | 807,914 |
| Total equity | 3,784,430 | 3,684,547 | 3,355,517 |
| | 0,104,400 | 0,007,077 | 0,000,011 |

Hua Hong Semiconductor Limited Condensed Consolidated Statement of Cash Flows (In US\$ Thousands)

| | For the Three Months Ended | | |
|--|----------------------------|----------------------------|----------------------------|
| | 31-Mar-2022 (Unaudited) | 31-Mar-2021 (Unaudited) | 31-Dec-2021 (Unaudited) |
| Cash flows from operating activities: | | | |
| Profit before tax | 95,238 | 19,777 | 167,463 |
| Depreciation and amortization | 117,227 | 71,158 | 80,117 |
| Share of profit of associates | (1,855) | (1,512) | (2,436) |
| Changes in working capital and others | (15,021) | (28,592) | (38,340) |
| Net cash flows generated from operating activities | 195,589 | 60,831 | 206,804 |
| Cash flows from investing activities: | | | |
| Payments for property, plant and equipment and intangible assets | (124,080) | (167,357) | (382,236) |
| Receipt of government grants of property, plant and equipment | 4,356 | - | 83,594 |
| Investment in an associate | - | (1,484) | - |
| Other cash flow generated from investing activities | 2,738 | 1,313 | 1,598 |
| Net cash flows used in investing activities | (116,986) | (167,528) | (297,044) |
| Cash flows from financing activities: | | | |
| Proceeds from bank borrowings | 47,413 | 143,208 | 275,021 |
| Proceeds from issue of shares | 1,252 | 6,498 | 410 |
| Repayment of bank borrowings | (43,208) | - | (26,099) |
| Payment of lease liabilities | (2,484) | (2,709) | (632) |
| Interest paid | (534) | (69) | (6,513) |
| Net cash flows generated from financing activities | 2,439 | 146,928 | 242,187 |
| Net increase in cash and cash equivalents | 81,042 | 40,231 | 151,947 |
| Effects of exchange rate changes | 3,752 | (1,511) | 13,846 |
| Cash and cash equivalents, beginning of period | 1,610,140 | 922,786 | 1,444,347 |
| Cash and cash equivalents, ending of period | 1,694,934 | 961,506 | 1,610,140 |

As of the date of this announcement, the directors of the Company are:

Executive Directors

Suxin Zhang (Chairman) Junjun Tang (President)

Non-Executive Directors

Guodong Sun Jing Wang Jun Ye

Independent Non-Executive Directors

Stephen Tso Tung Chang Kwai Huen Wong, JP Long Fei Ye

By order of the Board

Hua Hong Semiconductor Limited

Mr. Suxin Zhang

Chairman and Executive Director

Hong Kong SAR, PRC May 12, 2022